

# Tervetuloa O-johtavaan

O-Leading pyrkii olemaan yhden luukun ratkaisukumppanisi EMS-toimitusketjussa, mukaan lukien piirilevyjen suunnittelu, piirilevyjen valmistus ja piirilevyjen kokoaminen (PCBA). Tarjoamme joitain edistyneimmistä piirilevytekniikoista, mukaan lukien HDI-piirilevyt, monikerroksiset piirilevyt, jäykät ja joustavat piirilevyt. Voimme tukea prototyypin nopeasta kääntämisestä keskisuurten ja massatuotantoon. ([Pienen määrän pcb-valmistaja](#))

Yleisesti ottaen globaalit asiakkaamme ovat erittäin vaikuttuneita palveluistamme: nopea reagointi, kilpailukykyinen hinta ja sitoutuminen laatuun. Arvokkaamman teknisen palvelun ja kokonaisratkaisun tarjoaminen on O-tapa edetä.

Tulevaisuuden näkökulmasta O-johtava keskittyy aina elektroniikan valmistustekniikan innovaatioihin ja kehitykseen ja pyrkii jatkuvasti PCB:n ja PCBA:n keskitettyyn palveluun tarjoamaan ensiluokkaisia palveluita ja luomaan enemmän arvoa asiakkaillemme.

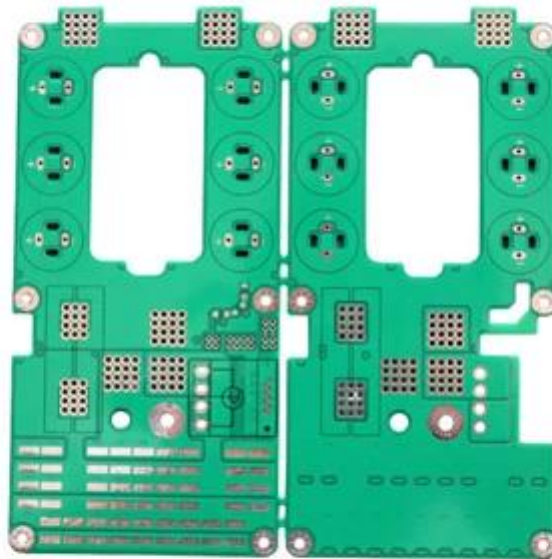
Olemme ammattimainen piirilevyjen valmistaja, jolla on yli kymmenen vuoden kokemus. Tuotevalikoima: yksi, kaksipuolinen, monikerroksinen piirilevy, joustava piirilevy ja MCPCB. Voimme tarjota nopean prototyyppipalvelun - S / S 24 tuntia, 4-8 kerrosta 48-96 työtuntia. [PCB-prototyypin valmistaja Kiina](#)

KUPARIYYTYSÄIVAT MINIMAALISET .025 AVG, .020 MIN .. reikiä EI SAA kytkeä

Pakkaus värittömällä läpinäkyvällä kuplakalvolla, 25 kpl / pussi, laita kuivausaine kylkeen, laita kosteuden ilmaisinkortti yläpuolelle

## Tuotteen Kuvaus

|                      |                                                    |                    |                |
|----------------------|----------------------------------------------------|--------------------|----------------|
| Lähtöisin            | Guang dong, Kiina (Manner)                         | Tuotenimi          | O-Johtavat     |
| Malli Number         | voimapankki pcb-kokoonpano pcba-valmistaja         | Pohjamateriaalia   | FR-4, alumiini |
| merkki               | Teollisuuden ohjaus pcb                            | Levyn paksuus      | 0.1-5mm        |
| Min. Reiän koko      | 0.2mm                                              | Min. Viivan leveys | 0.2mm          |
| Pinnan viimeistely   | upotuskulta, OSP, lyijytön HASL                    | min.Line Väli      | 0.2mm          |
| Color                | sininen, punainen, vihreä, musta.väri              | hinta              | \$ 0,1- \$ 10  |
| sovellettava tO      | led, matkapuhelin, ilmastointilaitteet, pesukoneet | Kuparin paksuus    | 0.5oz-5oz      |
| todistukset          | ISO9001, UL, RoHS, SGS                             | koko               | 0.01m3-10m3    |
| suunta tyyppiQ / CTN | asiakasvaatimus                                    | Q / CTN            | 10PCS-100PCS   |
| paino                | 0,01-5 kg                                          | MOQ                | 10kpl          |



[www.o-leading.com](http://www.o-leading.com)

Kiina jäykästi joustava pcb-valmistaja

Tiimimme



## Factory PCB



Automatic vacuum press machine



Drilling Machine



Pattern Plating Machine



Scrubbing Machine



Developing Machine



Routing Machine



High-speed flying probe machine



E-test Machine

## Factory SMT







## Test Report

No. SZXEC1900530401

Date: 30 Mar 2019

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O-LEADING SUPPLY CHAIN (HK) CO., LIMITED

1313.FLOOR 13, FORTUNE BUILDING, DANSHUI TOWN, HUIYANG DISTRICT, HUIZHOU, GUANGDONG, CHINA

The following sample(s) was/were submitted and identified on behalf of the clients as : OSP

SGS Job No. : RP19-005089 - SZ

Date of Sample Received : 22 Mar 2019

Testing Period : 22 Mar 2019 - 30 Mar 2019

Test Requested : Selected test(s) as requested by client.

Test Method : Please refer to next page(s).

Test Results : Please refer to next page(s).

Conclusion : Based on the performed tests on submitted sample(s), the results of Lead, Mercury, Cadmium, Hexavalent chromium, Polybrominated biphenyls (PBBs), Polybrominated diphenyl ethers (PBDEs) and Phthalates such as Bis(2-ethylhexyl) phthalate (DEHP) , Butyl benzyl phthalate (BBP), Dibutyl phthalate (DBP) , and Diisobutyl phthalate (DIBP) comply with the limits as set by RoHS Directive (EU) 2015/863 amending Annex II to Directive 2011/65/EU.

Signed for and on behalf of  
SGS-CSTC Standards Technical Services Co., Ltd. Shenzhen Branch

Tina Fan  
Approved Signatory



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## Test Report

No. SZXEC1900530401

Date: 30 Mar 2019

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Test Results :

### Test Part Description :

| Specimen No. | SGS Sample ID    | Description |
|--------------|------------------|-------------|
| SN1          | SZX19-005304.001 | Green"PCB"  |

Remarks :

- (1) 1 mg/kg = 1 ppm = 0.0001%
- (2) MDL = Method Detection Limit
- (3) ND = Not Detected ( < MDL )
- (4) "-" = Not Regulated

### RoHS Directive (EU) 2015/863 amending Annex II to Directive 2011/65/EU

Test Method : With reference to IEC 62321-4:2013+A1:2017, IEC 62321-5:2013, IEC 62321-7-2:2017, IEC 62321-6:2015 and IEC 62321-8:2017, analyzed by ICP-OES, UV-Vis and GC-MS.

| Test item(s)                 | Limit | Unit  | MDL | Q/Z |
|------------------------------|-------|-------|-----|-----|
| Cadmium (Cd)                 | 100   | mg/kg | 2   | ND  |
| Lead (Pb)                    | 1,000 | mg/kg | 2   | 8   |
| Mercury (Hg)                 | 1,000 | mg/kg | 2   | ND  |
| Hexavalent Chromium (Cr(VI)) | 1,000 | mg/kg | 8   | ND  |
| Sum of PBBs                  | 1,000 | mg/kg | -   | ND  |
| Monobromobiphenyl            | -     | mg/kg | 5   | ND  |
| Dibromobiphenyl              | -     | mg/kg | 5   | ND  |
| Tribromobiphenyl             | -     | mg/kg | 5   | ND  |
| Tetrabromobiphenyl           | -     | mg/kg | 5   | ND  |
| Pentabromobiphenyl           | -     | mg/kg | 5   | ND  |
| Hexabromobiphenyl            | -     | mg/kg | 5   | ND  |
| Heptabromobiphenyl           | -     | mg/kg | 5   | ND  |
| Octabromobiphenyl            | -     | mg/kg | 5   | ND  |
| Nonabromobiphenyl            | -     | mg/kg | 5   | ND  |
| Decabromobiphenyl            | -     | mg/kg | 5   | ND  |
| Sum of PBDEs                 | 1,000 | mg/kg | -   | ND  |
| Monobromodiphenyl ether      | -     | mg/kg | 5   | ND  |
| Dibromodiphenyl ether        | -     | mg/kg | 5   | ND  |
| Tribromodiphenyl ether       | -     | mg/kg | 5   | ND  |
| Tetrabromodiphenyl ether     | -     | mg/kg | 5   | ND  |
| Pentabromodiphenyl ether     | -     | mg/kg | 5   | ND  |



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## ZPMV2.E490354 - WIRING, PRINTED - COMPONENT

## Wiring, Printed - Component

See General Information for Wiring, Printed - Component

**O-LEADING SUPPLY CHAIN (HK) CO LTD**

E490354

ROOM 1205, 12/F  
TAI SANG BANK BLDG  
130-132 DES VOEUS ROAD  
CENTRAL, HONG KONG

| Type                                              | Cond Width    |               | Cond<br>Thk<br>mic(mil) | SS/<br>DS/<br>DSO | Max        | Max    |      |       |       |     |   |
|---------------------------------------------------|---------------|---------------|-------------------------|-------------------|------------|--------|------|-------|-------|-----|---|
|                                                   | Min           | Min           |                         |                   | Area       | Solder | Oper | Meets | C     |     |   |
|                                                   | Edge          | Thk           |                         |                   | Diam       | Limits | Temp | Flame | UL796 | T   |   |
| mm(in)                                            | mm(in)        |               |                         | mm(in)            | C          | sec    | C    | Class | DSR   | I   |   |
| Multilayer (mass laminate) printed wiring boards. |               |               |                         |                   |            |        |      |       |       |     |   |
| O-LEADING-401                                     | 0.1 (0.004)   | 0.3 (0.012)   | 34 (1.34)               | DS                | 12.7 (0.5) | 260    | 10   | 130   | V-0   | -   | - |
| O-LEADING-407                                     | 0.08 (0.003)  | 0.2 (0.008)   | 17 (0.67)               | DS                | 9.7 (0.4)  | 260    | 10   | 130   | V-0   | All | - |
| Multilayer printed wiring boards.                 |               |               |                         |                   |            |        |      |       |       |     |   |
| O-LEADING-408                                     | 0.125 (0.005) | 0.125 (0.005) | 12 (0.47)<br>Int:136    | DS                | 50.8 (2.0) | 280    | 20   | 130   | V-0   | All | * |
| Single layer printed wiring boards.               |               |               |                         |                   |            |        |      |       |       |     |   |
| O-LEADING-002                                     | 0.38 (0.015)  | 1.14 (0.045)  | 34 (1.34)               | SS                | 19.1 (0.8) | 260    | 10   | 105   | V-0   | All | - |
| O-LEADING-003                                     | 0.38 (0.015)  | 1.14 (0.045)  | 34 (1.34)               | SS                | 19.1 (0.8) | 260    | 10   | 130   | V-0   | ▲   | - |
| O-LEADING-033                                     | 0.15 (0.006)  | 0.3 (0.012)   | 34 (1.34)               | SS                | 25.4 (1.0) | 260    | 10   | 120   | V-0   | All | - |
| O-LEADING-205                                     | 0.1 (0.004)   | 0.3 (0.012)   | 34 (1.34)               | DS                | 69.6 (2.7) | 260    | 10   | 130   | V-0   | All | - |
| O-LEADING-206                                     | 0.15 (0.006)  | 0.33 (0.013)  | 17 (0.67)               | DS                | 69.6 (2.7) | 260    | 10   | 130   | V-0   | All | - |
| O-LEADING-D01                                     | 0.14 (0.006)  | 0.15 (0.006)  | 33 (1.30)               | DS                | 25.4 (1.0) | 260    | 10   | 130   | V-0   | All | * |
| O-LEADING-S01                                     | 0.25 (0.010)  | 0.25 (0.010)  | 17 (0.67)               | SS                | 25.4 (1.0) | 260    | 4    | 130   | V-0   | All | * |

## WIRING, PRINTED - COMPONENT | UL Product iQ

|                      |              |              |           |    |            |     |   |     |     |     |   |
|----------------------|--------------|--------------|-----------|----|------------|-----|---|-----|-----|-----|---|
| <b>O-LEADING-S02</b> | 0.2 (0.008)  | 0.2 (0.008)  | 17 (0.67) | SS | 25.4 (1.0) | 260 | 4 | 130 | HB  | ▲   | * |
| <b>O-LEADING-S03</b> | 0.25 (0.010) | 0.25 (0.010) | 34 (1.34) | SS | 25.4 (1.0) | 260 | 4 | 130 | V-0 | All | * |

\* - CTI marking is optional and may be marked on the printed wiring board.

Marking: Company name or file number and type designation. May be followed by a suffix to denote factory identification or burning test classification.

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## Shipping service



| Quick Turn Lead Time |          |                     |
|----------------------|----------|---------------------|
| Layer Count:         | Lead Tim | Special Requirement |
| 1L/2L                | 2-3days  | 24 Hours,48 Hours   |
| 4L                   | 3-4days  | 48 Hours            |
| 6L                   | 4-5days  | 72 Hours            |
| 8L                   | 5-6days  | NA                  |
| 10L                  | 6-7days  | NA                  |
| 12L                  | 7-8days  | NA                  |
| 14L                  | 8-9days  | NA                  |

| Standard Lead Time |                  |                        |
|--------------------|------------------|------------------------|
| Layer Count:       | Sample Lead Time | Volume order lead time |
| 2L                 | 4 days           | 10 days                |
| 4L                 | 5 days           | 11 days                |
| 6L                 | 6 days           | 12 days                |
| 8L                 | 8 days           | 14 days                |
| 10L                | 10 days          | 16 days                |
| 12L                | 12 days          | 18 days                |
| 14L                | 14 days          | 20 days                |
| 16-32L             | 18 days          | 24 days                |

## Prosessin kyky

### Piirilevyjen tuotantokapasiteetit

Kerros määrä: 1-kerros-32-kerros

Valmiiden kuparien paksuus □ 1 / 3oz-12oz

Min Rivin leveys / etäisyys sisäinen □ 3,0mil / 3,0mil

Min Rivin leveys / välinen etäisyys: 4,0mil / 4,0mil

Suurin kuvasuhde: 10: 1

Levyn paksuus □ 0,2-5,0 mm

Paneelin enimmäiskoko (tuumaa): 635 \* 1500 mm

Poratun reiän vähimmäiskoko: 4mil

PI-reikätoleranssi: +/- 3mil

Blind / Buried Vias (All-tyypit): YES

Täyttämällä (johtava, johtamaton): KYLLÄ

Pohjamateriaali: FR-4, FR-4korkean painon halogeeniton materiaali, Rogers, alumiininen pohja,polyimidi,  
Raskas kupari

Pintakäsittelyt: HASL, OSP, ENIG, HAL-LF, hopea,Lummersion Tina, kultaiset sormet, hiilimuste

### SMT-tuotantokapasiteetit

Piirilevymateriaali: FR-4, CEM-1, CEM-3, alumiinipohjainen levy

Suurin piirilevyn koko: 510x460 mm

Minimi piirilevyn koko  $\square$  50x50mm

Piirilevyn paksuus  $\square$  0,5-4,5 mm

Levyn paksuus  $\square$  0,5-4mm

Komponenttien vähimmäiskoko: 0201

Tavallinen sirukoko-komponentti: 0603 ja suurempi

Komponentin enimmäiskorkeus  $\square$  15mm

Min. Lyijyväli: 0,3 mm

Minimi BGA-palloväli: 0,4 mm

Sijoituksen tarkkuus: +/- 0,03 mm